

ISL71610SLHM

Radiation Hardened Passive-Input Digital Isolator

The [ISL71610SLHM](#) is a passive-input digital signal isolator with a CMOS output. It has a similar interface but with better performance and higher package density than optocouplers.

The ISL71610SLHM is manufactured with Giant Magnetoresistive (GMR) technology for small size, high speed, and low power. A ceramic/polymer composite barrier provides excellent isolation and an unlimited barrier life. A series external resistor sets the input coil current and a capacitor in parallel with the current-limiting resistor provides improved dynamic performance. This versatile component can replace a variety of optocouplers, functioning over a wide range of data rates, edge speeds, and power supply levels. The device output is compatible with 3.3V and 5V supplies, allowing an interface to controllers without additional level shifting. With the coil energized with a minimum of $\pm 8\text{mA}$ (bidirectional current), the ISL71610SLHM is suitable for single-ended and differential drive applications.

The ISL71610SLHM is offered in an 8 Ld 5mmx4mm SOIC package and is fully specified across the military ambient temperature range of -55°C to $+125^{\circ}\text{C}$.

Applications

- Isolated power
- CAN bus/device net
- Differential line receiver
- Optocoupler replacement
- SPI interface
- RS-485, RS-422, or RS-232

Features

- Electrically screened to VID [V62/23619](#)
- Barrier Voltage Endurance
 - $2.5\text{kV}_{\text{RMS}}$, for 1 minute, 600V_{RMS} continuous (VDE V 0884-10 certified: file 5022321-4880-0001)
 - 1.5kV_{DC} continuous
 - 500V_{DC} at $60\text{MeV}\cdot\text{cm}^2/\text{mg}$ SEDR
- Production testing and qualification follow the AS6294/1 standard (see [Radiation Hardened Plastic Production and QCI Flow](#))
- UL 1577 recognized: file reference E483309
- Up to 100Mbps data rate
- Flexible inputs with very wide input voltage range (resistor limited current through coil)
- No carrier or clock for low EMI emissions and susceptibility
- 3V to 5.5V signaling operation
- Passes NASA low outgassing specifications
- NiPdAu-Ag lead frames (Pb-free, Sn-free)
- Full military temperature range operation
 - $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$
 - $T_J = -55^{\circ}\text{C}$ to $+150^{\circ}\text{C}$
- TID Rad Hard Assurance (RHA) testing
 - Low Lose Rate (LDR) $(0.01\text{rad}(\text{Si})/\text{s})$: $75\text{krad}(\text{Si})$
- SEE Characterization
 - No DSEE with $V_{\text{DD}} = 6.5\text{V}$ at $\text{LET} = 86\text{MeV}\cdot\text{cm}^2/\text{mg}$

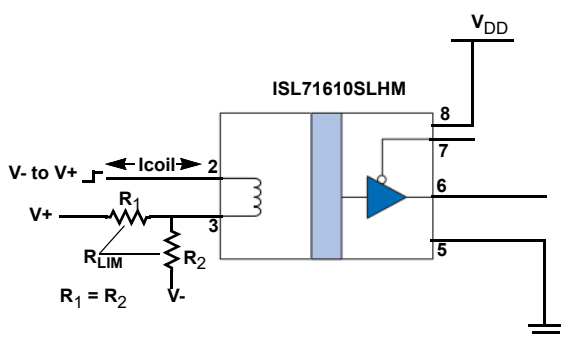


Figure 1. Single-Ended Configuration

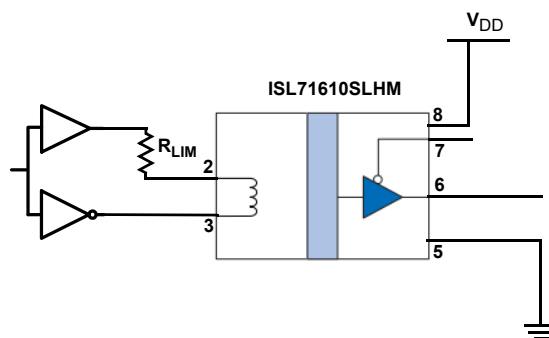


Figure 2. Differential Configuration

Contents

1. Overview	3
1.1 Functional Block Diagram	3
2. Pin Information	4
2.1 Pin Assignments	4
2.2 Pin Descriptions	4
3. Specifications	5
3.1 Absolute Maximum Ratings	5
3.2 Outgas Testing	5
3.3 Thermal Information	5
3.4 Recommended Operating Conditions	6
3.5 Insulation Specifications	6
3.6 Safety and Approvals	6
3.7 Electrical Specifications	7
4. Typical Performance Graphs	10
5. Device Information	14
5.1 Coil Polarity	14
5.2 Input Resistor Selection	14
5.3 Single-Ended or Differential Input	14
5.4 Non-Inverting and Inverting Configurations	14
5.5 Boost Capacitor	14
5.6 Dynamic Power Consumption	15
5.7 Power Supply Decoupling	15
5.8 Maintaining Creepage	15
5.9 Electromagnetic Compatibility and Magnetic Field Immunity	15
5.10 Data Rate and Magnetic Field Immunity	15
6. Package Outline Drawing	16
7. Ordering Information	17
8. Revision History	17

1. Overview

1.1 Functional Block Diagram

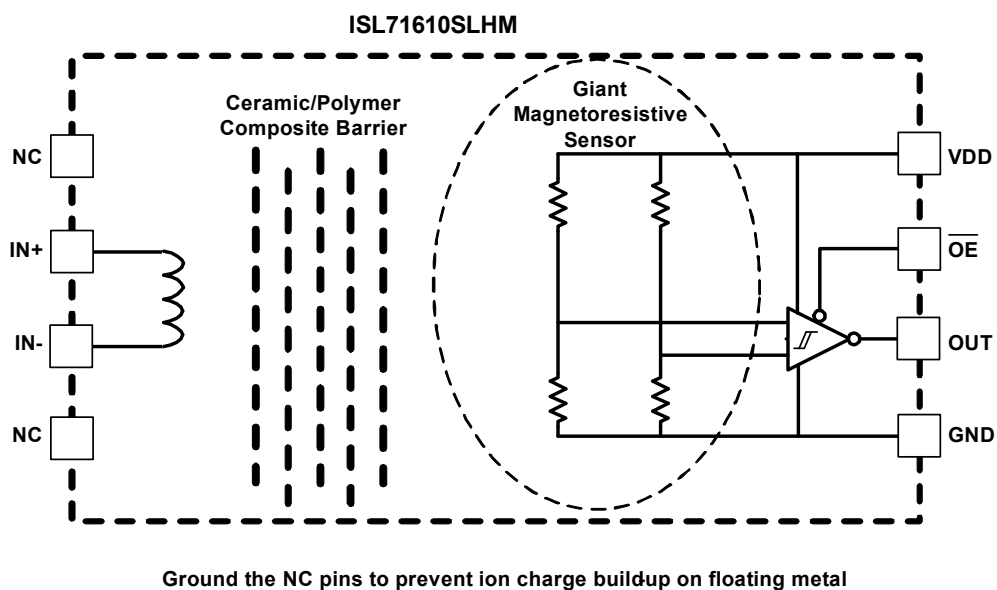
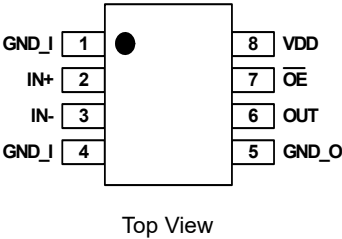


Figure 3. Block Diagram

2. Pin Information

2.1 Pin Assignments



2.2 Pin Descriptions

Pin Number	Pin Name	ESD Circuit	Description
1, 4	GND_I	N/A	No internal connection. Use for input shielding, connect to input side ground
2	IN+	N/A	Coil connection. The voltage applied to IN+ is more negative than IN- to cause the voltage of OUT to switch to V_{OL} (logic low).
3	IN-	N/A	Coil connection. The voltage applied to IN- is more positive than IN+ to cause the voltage of OUT to switch to V_{OL} (logic low).
5	GND_O	N/A	Ground return for VDD
6	OUT	2	Data output. The OUT pin logic high is the zero input current state.
7	\overline{OE}	1	Output enable, active low. Internally pulled low with 100k Ω to enable the output when this pin is not connected.
8	VDD	N/A	Receiver supply voltage

Circuit 1

Circuit 2

3. Specifications

3.1 Absolute Maximum Ratings

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

Parameter	Minimum	Maximum	Unit
VDD	GND - 0.3	GND + 7	V
IN+, IN-	-25	25	mA
OUT, $\overline{\text{OE}}$	GND - 0.3	V _{DD} + 1.5	V
OUT, $\overline{\text{OE}}$	-10	10	mA
Voltage Difference Across the Package (Pins 1, 2, 3, 4 to Pins 5, 6, 7, 8)	-	500	V
Power Dissipation	-	675	mW
Human Body Model (Tested per AEC-Q100-002)	-	1.2	kV
Charged Device Model (Tested per AEC-Q100-011)	-	1.5	kV
Latch-up (Tested per JESD-78E; Class 2, Level A) at +125°C	-	100	mA

3.2 Outgas Testing

Specification (Tested per ASTM E595, 1.5)	Value	Unit
Total Mass Lost ^[1]	0.06	%
Collected Volatile Condensable Material ^[1]	<0.01	%
Water Vapor Recovered	0.03	%

1. Outgassing results meet NASA requirements of total mass loss <1% and collected volatile condensable material of <0.1%.

3.3 Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W) ^[1]	θ_{JC} (°C/W) (Top)	θ_{JC} (°C/W) (Bottom)	Ψ_{JT} (°C/W) ^[2]
NSOIC Package M8.15G	60	73	40	10

1. θ_{JA} is measured with the component soldered to double-sided board; free air.

2. For Ψ_{JT} characterization parameter, the package top temperature is measured at the top center of the mounted package. See [TB379](#).

Parameter	Minimum	Maximum	Unit
Junction Temperature	-55	+150	°C
Storage Temperature Range	-65	+150	°C
Pb-Free Reflow Profile	See TB493		

3.4 Recommended Operating Conditions

Parameter	Minimum	Maximum	Unit
Ambient Temperature	-55	+125	°C
VDD	3	5.5	V
OUT, $\overline{\text{OE}}$	0	V _{DD}	V
OUT	-4	4	mA
Maximum Coil Current	-20	20	mA
Minimum Coil Current to Ensure Correct Output	-8	8	mA

3.5 Insulation Specifications

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Creepage Distance (external)		IPC-2221B	2.54		-	mm
Total Barrier Thickness (internal)			12	13	-	μm
Leakage Current		240V _{RMS} , 60Hz	-	200	-	nA
Barrier Resistance	R _{IO}	500V _{DC}	-	>100	-	TΩ
Barrier Capacitance	C _{IO}	1MHz	-	7	-	pF
Comparative Tracking Index	CTI	Per IEC:60112	>175	-	-	V
AC High Voltage Endurance (Maximum Barrier Voltage for Indefinite Life)	V _{IOAC}	+125°C ambient	600	-	-	V _{RMS}
DC High Voltage Endurance (Maximum Barrier Voltage for Indefinite Life)	V _{IODC}	+125°C ambient	1500	-	-	V
Barrier Life	-	100°C, 1000 V _{RMS} , 60% Confidence Level activation energy	-	4400 0	-	Year s

3.6 Safety and Approvals

3.6.1 VDE V 0884-10 (VDE V 0884-11 pending) (Basic Isolation; VDE File Number 5022321-4880-0001)

- Working voltage (V_{IORM}): 600V_{RMS} (848V_{PK}); basic insulation; pollution degree 2
- Isolation voltage (V_{ISO}): 2500V_{RMS}
- Transient overvoltage (V_{IOTM}): 4000V_{PK}
- Surge rating: 4000V
- Each part tested at 1590V_{PK} for 1s, 5pC partial discharge limit
- Samples tested at 4000V_{PK} for 60s; then 1358V_{PK} for 10s with 5pC partial discharge limit

Safety-Limiting Values	Symbol	Value	Unit
Safety Rating Ambient Temperature	T _S	+180	°C
Safety Rating Power	P _S	270	mW
Supply Current Safety Rating (Total of Supplies)	I _S	54	mA

3.6.2 UL 1577 (Component Recognition Program File Number E483309)

- Each part tested at 3000V_{RMS} (4240V_{PK}) for 1s; each lot sample tested at 2500V_{RMS} (3530V_{PK}) for 1min

3.7 Electrical Specifications

Unless otherwise noted, V_{DD} = 3V - 5.5V; OUT and $\overline{\text{OE}}$ are open, V_{DD} is bypassed to GND with a 47nF X7R capacitor; T_A = T_J = +25°C. Limits apply across the operating temperature range, -55°C to +125°C, unless otherwise stated.

Parameter	Symbol	Test Conditions	Min ^[1]	Typ	Max ^[1]	Unit
Input Specifications						
Coil Input Resistance	R _{COIL}	T = 25°C	47	85	112	Ω
Coil Input Resistance	R _{COIL}	T = -55°C	31	60	-	Ω
Coil Input Resistance	R _{COIL}	T = 125°C	-	115	138	Ω
Coil Resistance Temperature Coefficient ^[2]	TC R _{COIL}	-	-	0.2	0.25	Ω/K
Coil Inductance	L _{COIL}	-	-	9	-	nH
DC High Input Threshold (5V)	I _{INH-DC}	Single-ended circuit, V _{DD} = 4.5V - 5.5V	0.5	1	-	mA
DC Low Input Threshold (5V)	I _{INL-DC}	Single-ended circuit, V _{DD} = 4.5V - 5.5V	-	3.5	8	mA
Differential High Input Threshold	I _{INH-DIFF}	Differential circuit, V _{DD} = 3V - 5.5V, C _{BOOST} = 0pF, symmetric reversing input	0.5	1	-	mA
Differential Low Input Threshold	I _{INL-DIFF}	Differential circuit, V _{DD} = 3V - 5.5V, C _{BOOST} = 0pF, symmetric reversing input	-	3.5	8	mA
Failsafe High Input Current (5V) ^[3]	I _{FS-HIGH}	Single-ended circuit, V _{DD} = 4.5V - 5.5V	-25	-	0.5	mA
Failsafe Low Input Current (5V) ^[3]	I _{FS-LOW}	Single-ended circuit, V _{DD} = 4.5V - 5.5V	5	-	25	mA
Input Signal Rise and Fall Times ^[2]	t _{IR} , t _{IF}	-	-	-	1	μs
Common-Mode Transient Immunity ^[2]	CM _H , CM _L	V _{TRANSIENT} = 300V _{PEAK}	15	20	-	kV/μs
5V Electrical Specifications (V_{DD} = 4.5V - 5.5V; T = -55°C to +125°C unless otherwise stated)						
5V Quiescent Supply Current	I _{DDQ}	IN+ = IN- = open	-	2	3	mA
Logic High Output Voltage	V _{OH}	V _{DD} = 5 V, OUT = 20μA	4.9	5	-	V
		V _{DD} = 5 V, OUT = 4mA	4.6	4.8	-	V
Logic High Output Drive Current	I _{OH}	V _{OUT} = 4V	-	-10	-7	mA
Logic Low Output Voltage	V _{OL}	V _{DD} = 5 V, OUT = -20μA	-	0	0.1	V
		V _{DD} = 5 V, OUT = -4mA	-	0.2	0.8	V
Logic Low Output Drive Current	I _{OL}	V _{OUT} = 0.8V	7	10	-	mA
Output Disable	V _{OE}	V _{DD} = 5 V	-	2.7	-	V
5 V Switching Specifications (V_{DD} = 4.5 V - 5.5 V; T = -55°C to +125°C unless otherwise stated)						
Data Rate	-	Single-ended circuit, t _{IR} = t _{IF} = 3ns, C _{BOOST} = 16pF, R _{OUT} = 1kΩ, C _{OUT} = 16pF	-	-	100	Mbps
Minimum Pulse-Width ^[2]	PW	Single-ended circuit, t _{IR} = t _{IF} = 3ns, C _{BOOST} = 16pF, R _{OUT} = 1kΩ, C _{OUT} = 16pF	10	-	-	ns
Propagation Delay Input to Output (High-to-Low)	t _{PHL}	Single-ended circuit, t _{IR} = t _{IF} = 3ns, C _{BOOST} = 16pF, R _{OUT} = 1kΩ, C _{OUT} = 16pF	-	8	15	ns
Propagation Delay Input to Output (Low-to-High)	t _{PLH}	Single-ended circuit, t _{IR} = t _{IF} = 3ns, C _{BOOST} = 16pF, R _{OUT} = 1kΩ, C _{OUT} = 16pF	-	8	15	ns

Unless otherwise noted, $V_{DD} = 3V - 5.5V$; OUT and \overline{OE} are open, V_{DD} is bypassed to GND with a 47nF X7R capacitor;
 $T_A = T_J = +25^\circ C$. Limits apply across the operating temperature range, $-55^\circ C$ to $+125^\circ C$, unless otherwise stated. (Continued)

Parameter	Symbol	Test Conditions	Min ^[1]	Typ	Max ^[1]	Unit
Average Propagation Delay Drift	t_{PDD}	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	10	-	ps/ $^\circ C$
Pulse Width Distortion $ t_{PHL}-t_{PLH} $	PWD	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	3	6	ns
Pulse Jitter	t_J	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	100	-	ps
Propagation Delay Skew ^[2]	t_{PSK}	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-2		2	ns
Propagation Delay Enable to Output (High-to-High Impedance)	t_{PHZ}	$C_L = 15pF$	-	3	7	ns
Propagation Delay Enable to Output (Low-to-High Impedance)	t_{PLZ}	$C_L = 15pF$	-	3	7	ns
Propagation Delay Enable to Output (High Impedance-to-High)	t_{PZH}	$C_L = 15pF$	-	3	7	ns
Propagation Delay Enable to Output (High Impedance-to-Low)	t_{PZL}	$C_L = 15pF$	-	3	7	ns
Output Rise Time (10% to 90%) ^[2]	t_R	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	2	4	ns
Output Fall Time (10% to 90%) ^[2]	t_F	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	2	4	ns
3.3V Electrical Specifications ($V_{DD} = 3V - 3.6V$; $T = -55^\circ C - 125^\circ C$ unless otherwise stated)						
3.3V Quiescent Supply Current	I_{DDQ}	IN+ = IN- = open	-	1.3	2	mA
Logic High Output Voltage	V_{OH}	$V_{DD} = 3.3V$, OUT = 20 μA	3.2	3.3	-	V
		$V_{DD} = 3.3V$, OUT = 4mA, $25^\circ C$, $-55^\circ C$	3.0	3.1	-	V
		$V_{DD} = 3.3V$, OUT = 4mA, $+125^\circ C$	2.85	3.0	-	V
Logic High Output Drive Current	I_{OH}	$V_{OUT} = 2V$	-	-10	-7	mA
Logic Low Output Voltage	V_{OL}	$V_{DD} = 3.3V$, OUT = -20 μA	-	0	0.1	V
Logic Low Output Voltage	V_{OL}	$V_{DD} = 3.3V$, OUT = -4mA	-	0.2	0.8	V
Logic Low Output Drive Current	I_{OL}	$V_{OUT} = 0.8V$	7	10	-	mA
Output Disable	V_{OE}	$V_{DD} = 3.3V$	-	1.6	-	V
3.3V Switching Specifications ($V_{DD} = 3V - 3.6V$; $T = -55^\circ C - 125^\circ C$ unless otherwise stated)						
Data Rate	-	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	-	100	Mbps
Minimum Pulse Width ^[2]	PW	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	10	-	-	ns
Propagation Delay Input to Output (High-to-Low)	t_{PHL}	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	12	18	ns
Propagation Delay Input to Output (Low-to-High)	t_{PLH}	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	12	18	ns
Average Propagation Delay Drift	t_{PDD}	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	10	-	ps/ $^\circ C$

Unless otherwise noted, $V_{DD} = 3V - 5.5V$; OUT and \overline{OE} are open, VDD is bypassed to GND with a 47nF X7R capacitor;
 $T_A = T_J = +25^\circ C$. Limits apply across the operating temperature range, $-55^\circ C$ to $+125^\circ C$, unless otherwise stated. (Continued)

Parameter	Symbol	Test Conditions	Min ^[1]	Typ	Max ^[1]	Unit
Pulse Width Distortion [tPHL-tPLH]	PWD	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	3	6	ns
Propagation Delay Skew ^[2]	t_{PSK}	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-2	-	2	ns
Propagation Delay Enable to Output (High-to-High Impedance)	t_{PHZ}	$C_L = 15pF$	-	3	7	ns
Propagation Delay Enable to Output (Low-to-High Impedance)	t_{PLZ}	$C_L = 15pF$	-	3	7	ns
Propagation Delay Enable to Output (High Impedance-to-High)	t_{PZH}	$C_L = 15pF$	-	3	7	ns
Propagation Delay Enable to Output (High Impedance-to-Low)	t_{PZL}	$C_L = 15pF$	-	3	7	ns
Output Rise Time (10% to 90%) ^[2]	t_R	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	3	5	ns
Output Fall Time (10% to 90%) ^[2]	t_F	Single-ended circuit, $t_{IR} = t_{IF} = 3ns$, $C_{BOOST} = 16pF$, $R_{OUT} = 1k\Omega$, $C_{OUT} = 16pF$	-	3	5	ns

1. Compliance to datasheet limits is assured by one or more methods: production test, characterization, and/or design.
2. Parameter not tested in production.
3. Failsafe Operation is defined as the input current required to guarantee an output state on power-up. To guarantee failsafe input energization, the DC current supplied to the coil must be at least 8mA using 3.3V supplies versus 5mA for 4.5V or higher supplies. The circuit is intrinsically open-circuit failsafe because the ISL71610SLHM is guaranteed to switch to a high state when the coil input current is less than 0.5mA.

4. Typical Performance Graphs

$V_{DD} = 5V$, $T_A = +25^\circ\text{C}$, unless otherwise specified.

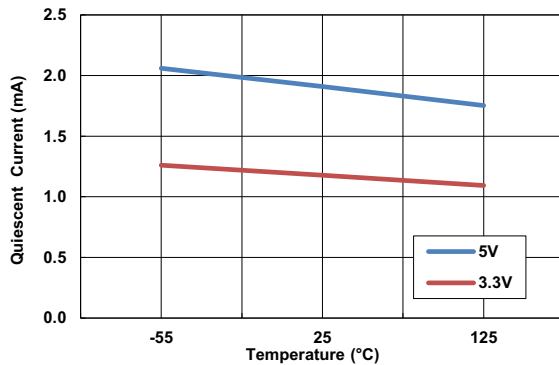


Figure 4. Quiescent Current vs Temperature, Voltage

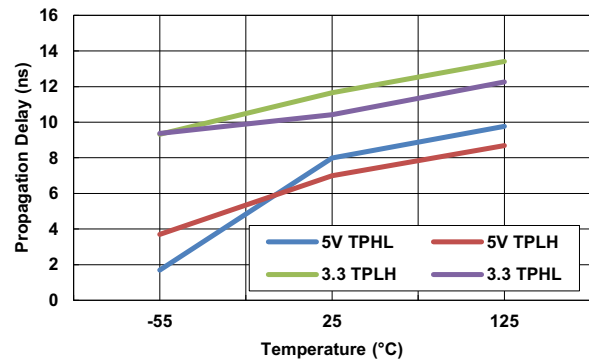


Figure 5. Propagation Delay vs Temperature, Voltage

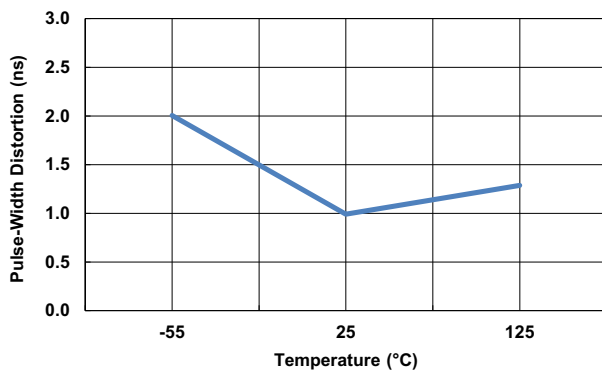


Figure 6. Pulse-Width Distortion vs Temperature

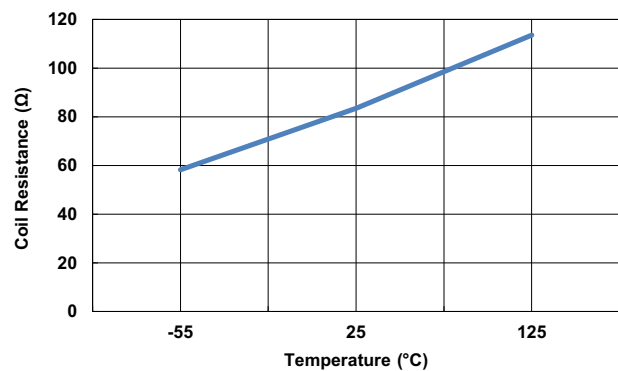


Figure 7. Coil Resistance vs Temperature

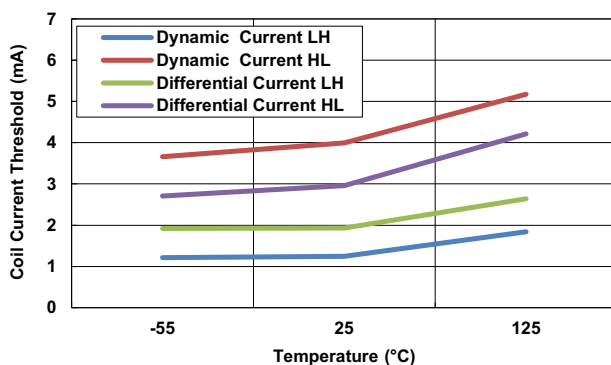


Figure 8. Coil Current Threshold vs Temperature, Voltage

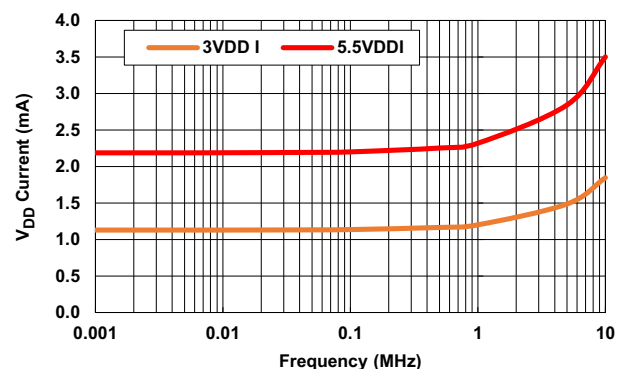


Figure 9. V_{DD} Current vs Frequency, Voltage, 0 Load, 50% Duty Cycle

$V_{DD} = 5V$, $T_A = +25^\circ C$, unless otherwise specified. (Continued)

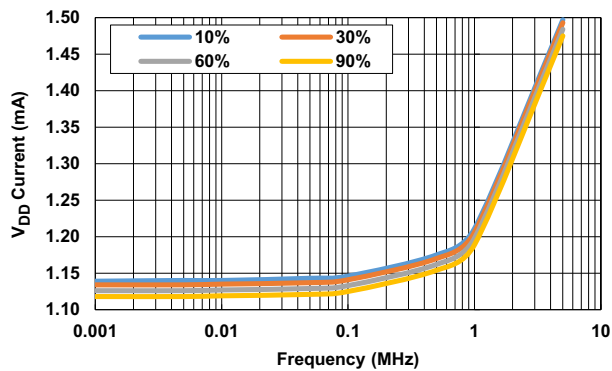


Figure 10. 3V V_{DD} Current vs Frequency, Duty Cycle, 0 load

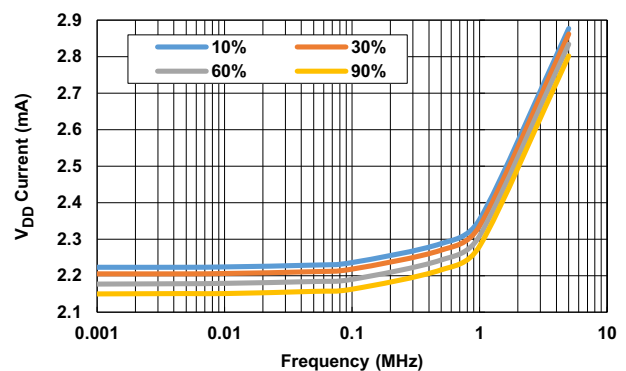


Figure 11. 5.5V V_{DD} Current vs Frequency, Duty Cycle, 0 load

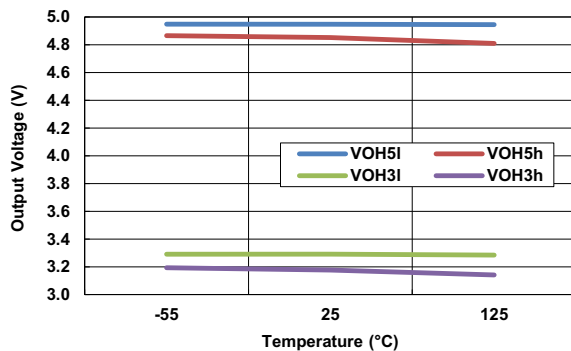


Figure 12. Output High Voltage for 5V and 3.3V with I_{OUT} of 20 μA and 4mA vs Temperature, Voltage

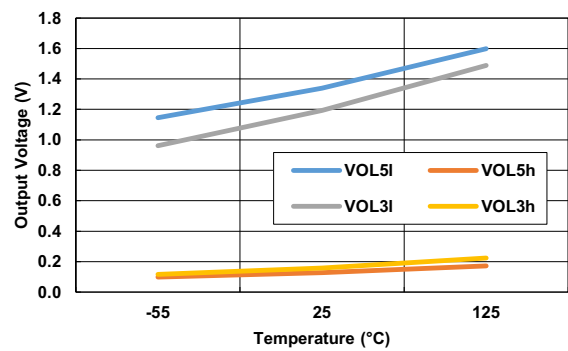


Figure 13. Output Low Voltage for 5V and 3.3V with I_{OUT} of 20 μA and 4mA vs Temperature, Voltage

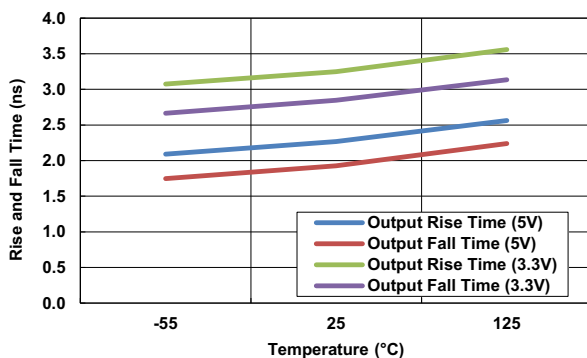


Figure 14. Rise and Fall Time vs Voltage, Temperature

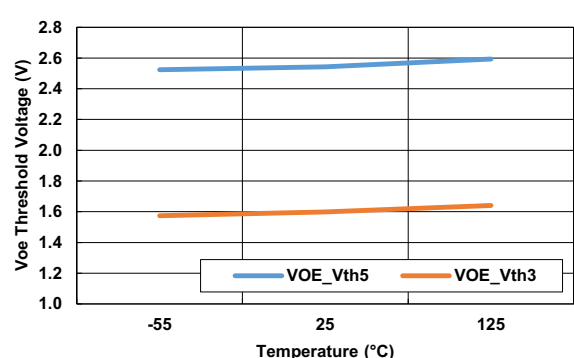


Figure 15. Output Enable Threshold vs Temperature, Voltage

$V_{DD} = 5V$, $T_A = +25^{\circ}C$, unless otherwise specified. (Continued)

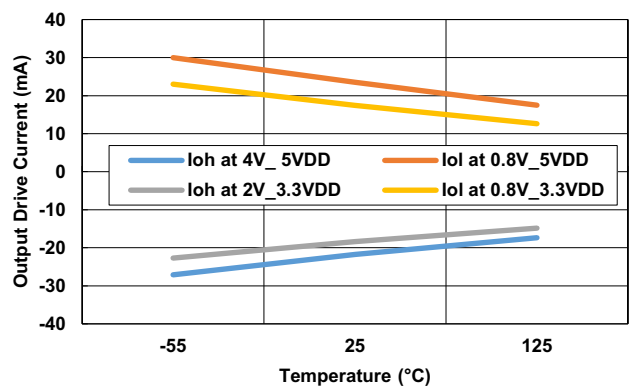


Figure 16. Output Drive Current Capability vs Temperature, Voltage

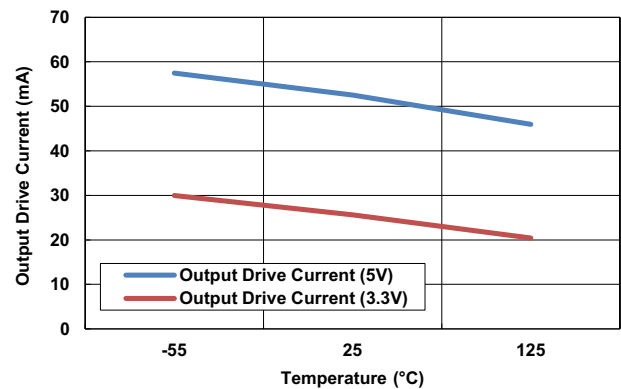


Figure 17. Shorted Output Drive Current Capability vs Temperature, Voltage

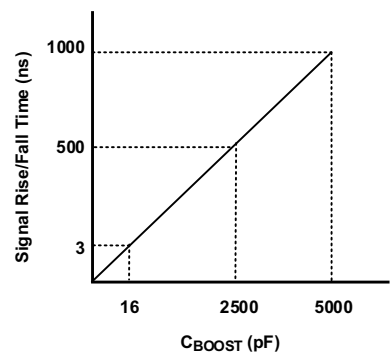


Figure 18. Boost Capacitor (C_{BOOST}) Selector Guide

$V_{DD} = 5V$, $T_A = +25^\circ C$, unless otherwise specified. VRlimit trace shows the timing of the coil current through the current limiting resistor and coil as a voltage across the resistor and coil, coil current rise/fall time $\sim 20ns$, V_{OUT} rise/fall time $\sim 10ns$.

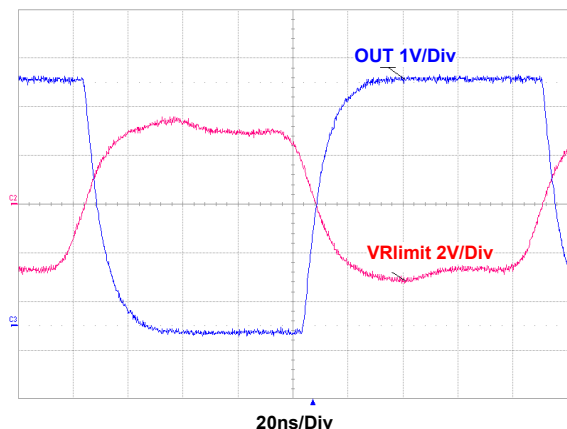


Figure 19. Switching, Coil Current $\sim \pm 8mA$,
 $C_{BOOST} = 15pF$, $C_{OUT} = 15pF$, $V_{DD} = 5V$

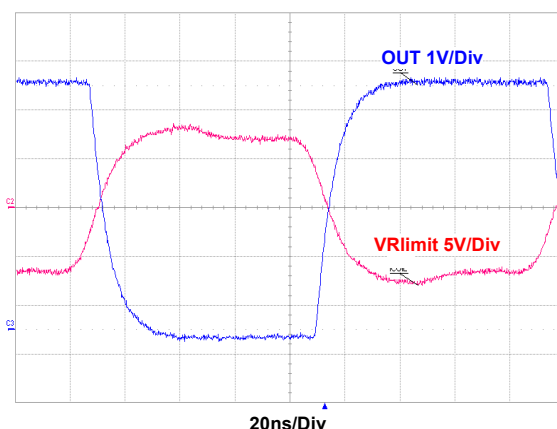


Figure 20. Switching, Coil Current $\sim \pm 18mA$,
 $C_{BOOST} = 15pF$, $C_{OUT} = 15pF$, $V_{DD} = 5V$

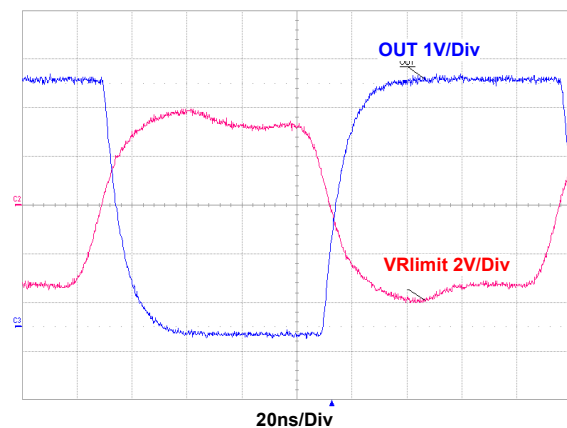


Figure 21. Switching, Coil Current $\sim \pm 8mA$,
 $C_{BOOST} = 5pF$, $C_{OUT} = 15pF$, $V_{DD} = 5V$

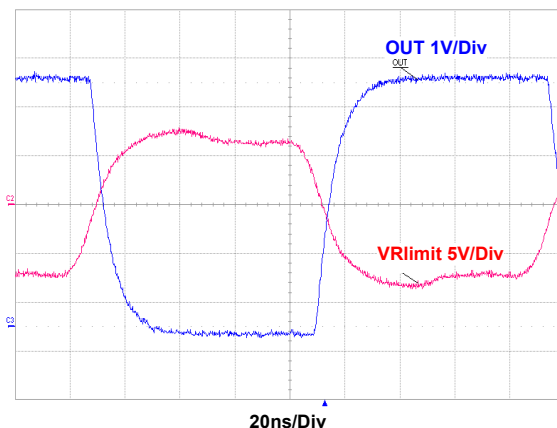


Figure 22. Switching, Coil Current $\sim \pm 18mA$,
 $C_{BOOST} = 5pF$, $C_{OUT} = 15pF$, $V_{DD} = 5V$

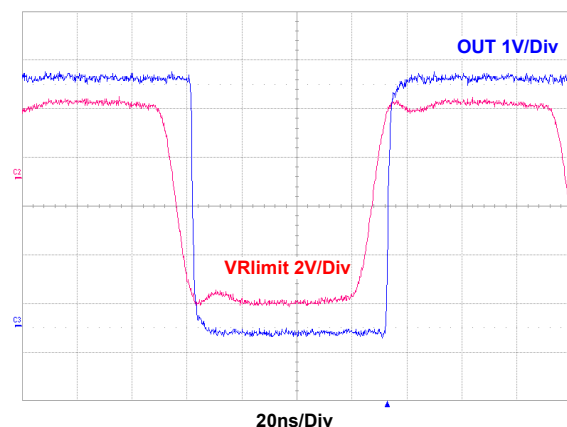


Figure 23. Non Inverting Configuration, Switching Coil
Current $\sim \pm 10mA$, $C_{BOOST} = 5pF$, $C_{OUT} = 15pF$, $V_{DD} = 5V$

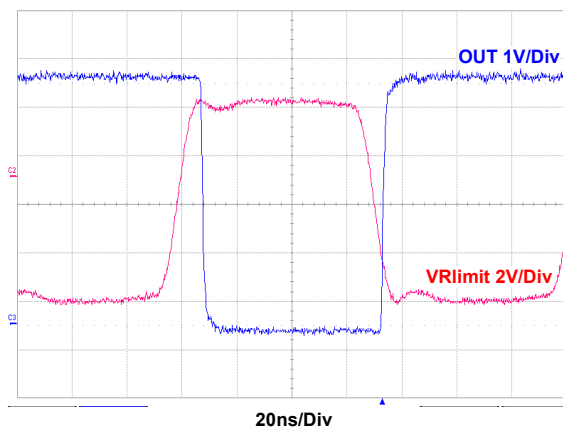


Figure 24. Inverting Configuration, Switching, Coil
Current $\sim \pm 10mA$, $C_{BOOST} = 5pF$, $C_{OUT} = 15pF$, $V_{DD} = 5V$

5. Device Information

The ISL71610SLHM isolator is a passive input current mode device. Changes in current flow into the input coil result in logic state changes at the output.

5.1 Coil Polarity

The ISL71610SLHM switches to logic low if current flows from the IN- pin to the IN+ pin. **Note:** The designations IN- and IN+ refer to logic levels, not current flow. Positive current values mean conventional current flows into the IN- input. To ensure an output state in an ion environment, the coil must be energized in either direction and must not be in a zero-current condition. [Figure 19](#) through [Figure 24](#) illustrate the bidirectional current drive waveforms.

5.2 Input Resistor Selection

A series resistor sets the coil input current. There is no limit to the input voltage amplitude because there are no semiconductor input structures. The minimum current amplitude for an assured output state across the voltage range is $\pm 8\text{mA}$. A boost capacitor creates current reversals at edge transitions, reducing the input logic low threshold current to the differential level of 5mA . For a 25°C 8mA coil current, a typical resistor value for 3.3V signaling is 324Ω , and a typical value for 5V signaling is 511Ω based on an 85Ω coil resistance. These values are approximate and should be adjusted for temperature or other application specifics. Consult the coil resistance specification and temperature coefficient graph for further information and guidance. If the expected temperature range is large, 1% tolerance resistors may provide additional design margin.

5.3 Single-Ended or Differential Input

You can run the ISL71610SLHM with single-ended or differential inputs. In differential mode, the current naturally flows through the coil in both directions without a boost capacitor although the capacitor can still be used for increased external field immunity or improved pulse-width distortion. Because of SEE testing results, the single-ended mode of operation should be implemented with $\pm 8\text{mA}$ minimum of coil current as shown in [Figure 1](#).

An advantage over optocouplers and other high-speed couplers in differential mode is that no reverse bias protection for the input structure is required for a differential signal.

One of the more common applications is for an isolated differential line receiver. For example, RS-485 can drive an ISL71610SLHM directly for a fraction of the cost of an isolated RS-485 node.

5.4 Non-Inverting and Inverting Configurations

ISL71610SLHM can be configured in non-inverting and inverting configurations, each is defined by the direction of current flow through the coil. In the non-inverting configuration current flows through the coil from the IN- side to the IN+ side. The +IN is at a higher voltage potential than the -IN.

5.5 Boost Capacitor

The boost capacitor in parallel with the current-limiting resistor boosts the instantaneous coil current at the signal transition. This ensures switching and reduces propagation delay and reduces pulse-width distortion.

Select the value of the boost capacitor based on the rise and fall times of the signal driving the inputs. The instantaneous boost capacitor current is proportional to input edge speeds ($C \cdot dV/dt$). Select a capacitor value based on the rise and fall times of the input signal to be isolated that provides approximately 20mA of additional boost current. For high-speed logic signals ($t_R, t_F < 10\text{ns}$), a 16pF capacitor is recommended. The capacitor value is generally not critical; if in doubt, choose a higher value. See [Figure 18](#).

5.6 Dynamic Power Consumption

Power consumption is proportional to duty cycle, not data rate. The use of NRZ coding minimizes power dissipation because no additional power is consumed when the output is in the high state. In differential mode, where the logic high condition may still require a current to be forced through the coil, power consumption is higher than a typical NRZ single-ended configuration. See [Figure 9](#) through [Figure 11](#) for typical power consumption performance.

5.7 Power Supply Decoupling

A 47nF low-ESR ceramic capacitor is recommended to decouple the power supply. Place the capacitor as close as possible to the VDD pin.

5.8 Maintaining Creepage

Creepage distances are often critical in isolated circuits. Standard pad libraries often extend under the package, compromising creepage and clearance. Similarly, if ground planes are used, space them to avoid compromising clearance.

5.9 Electromagnetic Compatibility and Magnetic Field Immunity

Because the ISL71610SLHM is completely static, it has the lowest emitted noise of any non-optical isolators. The ISL71610SLHM operates by imposing a magnetic field on a GMR sensor, which translates the change in field into a change in logic state. A magnetic shield and a Wheatstone Bridge configuration provide good immunity to external magnetic fields. Immunity to external magnetic fields can be enhanced by proper orientation of the device with respect to the field direction, the use of differential signaling, and boost capacitors.

5.9.1 Orientation of the Device with Respect to the Field Direction

An applied field into the pin edges of the package is the worst case for magnetic immunity. In this case, the external field is in the same direction as the applied internal field. In one direction it tends to help switching; in the other it hinders switching. This can cause unpredictable operation.

An applied field into the pin-less edges of the package has considerably less effect and results in higher magnetic immunity.

5.9.2 Differential Signaling and Boost Capacitors

Regardless of orientation, driving the coil differentially improves magnetic immunity because the logic high state is driven by an applied field instead of zero field, as is the case with single-ended operation. The higher the coil current, the higher the internal field and the higher the immunity to external fields. Optimal magnetic immunity is achieved by adding the boost capacitor.

5.10 Data Rate and Magnetic Field Immunity

It is easier to disrupt an isolated DC signal with an external magnetic field than it is to disrupt an isolated AC signal. Similarly, a DC magnetic field has a greater effect on the device than an AC magnetic field of the same effective magnitude. For example, signals with pulses longer than 100μs are more susceptible to magnetic fields than shorter pulse widths.

7. Ordering Information

Part Number ^{[1] [2]}	Part Marking	Radiation Tolerance (Total Ionizing Dose)	Package Description (RoHS Compliant)	Package Drawing	Carrier Type	Temp. Range
ISL71610SLHMBZ	71610SLH	LDR to 75krad(Si)	8 Ld NSOIC	M8.15G	Tray	-55 to +125°C
ISL71610SLHMEV1Z	Evaluation Board					

- These Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and NiPdAu-Ag plate-e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J-STD-020.
- For Moisture Sensitivity Level (MSL), see the [ISL71610SLHM](#) device page. For more information about MSL, see [TB363](#).

8. Revision History

Rev.	Date	Description
2.05	Feb 4, 2026	Added Note 3 to the Electrical Specifications section.
2.04	Dec 1, 2023	Updated Features section.
2.03	Nov 11, 2022	Added Figures 13, 15, and 16.
2.02	May 6, 2021	Added link to features bullet. Updated Title. Updated File number to Renesas numbering.
2.01	Mar 19, 2021	Applied latest template. Updated ordering information table.
2.00	Feb 17, 2021	Updated the AS6294/1 and SEE Characterization feature bullets. Removed Radiation Tolerance section and subsections.
1.00	Dec 18, 2020	Initial Release

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

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